



4A TrenchSBR TRENCH SUPER BARRIER RECTIFIER

Product Summary

| V _{RRM} (V) | I _O (A) | V _{F(MAX)} (V) @ +25°C | I _{R(MAX)} (mA) @ +25°C |
|----------------------|--------------------|------------------------------------|-------------------------------------|
| 45 | 4 | 0.52 | 0.1 |

Features and Benefits

- Patented TrenchSBR technology provides superior avalanche capability versus schottky diodes, ensuring more rugged and reliable end applications.
- Reduced ultra-low forward voltage drop (V_F); Better efficiency and cooler operation.
- Reduced high temperature reverse leakage. Increased reliability against thermal runaway failure in high temperature operation.
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Description and Applications

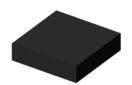
The SBRT4U45LP provides very low V_F and excellent reverse leakage stability at high temperatures. It is ideal for use as bypass diode and rectifier, freewheel diode or blocking diode in applications such as:

- Solar Panels
- Blocking Diode
- Bypass Diode
- Boost Diode
- · Recirculating Diode

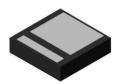
Mechanical Data

- Case: U-DFN2020-2 (Type B)
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe;
 Solderable per MIL-STD-202, Method 208 (23)
- Polarity: See Below
- Weight: 6.757 mg (Approximate)

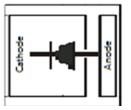
U-DFN2020-2 (Type B)







Bottom View



Top View Internal Schematic

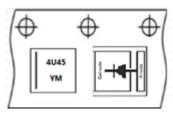
Ordering Information (Note 4)

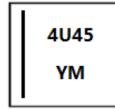
| Part Number | Case | Packaging |
|--------------|----------------------|-------------------|
| SBRT4U45LP-7 | U-DFN2020-2 (Type B) | 3,000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information





4U45 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: B = 2014)

M = Month (ex. 6 = June)

Bar = Cathode

Date Code Key

| Year | 2014 | 20 | 15 | 2016 | 2017 | 20 | 18 | 2019 | 2020 | 20: | 21 | 2022 |
|-------|------|-----|-----|------|------|-----|-----|------|------|-----|-----|------|
| Code | В | (| 2 | D | Е | F | - | G | Н | | | J |
| | | | | | | | | | | | | |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

| Characteristic | Symbol | Value | Unit |
|---|---|-------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _{RM} | 45 | > |
| Average Rectified Output Current | Io | 4 | Α |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I _{FSM} | 45 | А |

Thermal Characteristics

| Characteristic | | | Value | Unit |
|---|--|------------------|-------------------------------|------|
| Typical Thermal Resistance Junction to Case (Note 5) | | | 5 | °C/W |
| Typical Thermal Resistance Junction to Ambient (Note 5) | | | 65 | °C/W |
| Operating Temperature Range | $V_R \le 80\% V_{RRM}$ $V_R \le 50\% V_{RRM}$ DC Forward Mode (Note 7) | T_J | -55 to +150 ≤+175 ≤+200 | ô |
| Storage Temperature Range | | T _{STG} | -55 to +150 | °C |

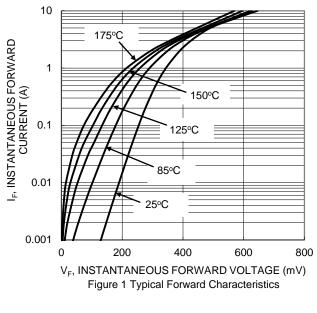
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

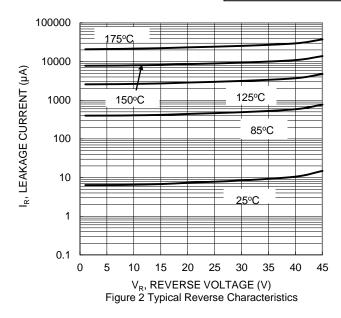
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|-------------------------------|---------|-----|-----|------|------|----------------------------------|
| Forward Voltage Drop (Note 6) | V_{F} | _ | _ | 0.52 | V | $I_F = 4A, T_J = +25^{\circ}C$ |
| Leakage Current (Note 6) | 1- | _ | _ | 100 | μA | $V_R = 45V, T_J = +25^{\circ}C$ |
| Leakage Current (Note 6) | IR | _ | 4.7 | _ | mA | $V_R = 45V, T_J = +125^{\circ}C$ |

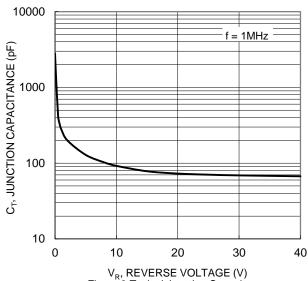
Notes:

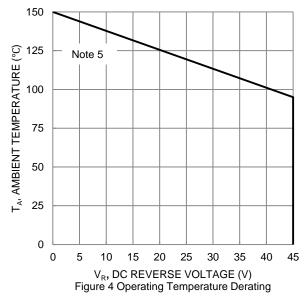
- 5. Device mounted on FR-4 PCB pad layout 1-inch 2oz copper.
- 6. Short duration pulse test used to minimize self-heating effect.
- 7. Max junction temperature guaranteed for two hours.

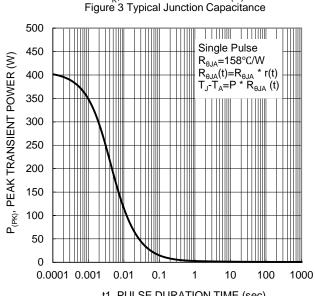


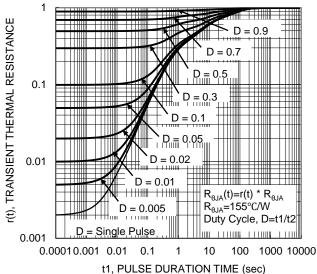










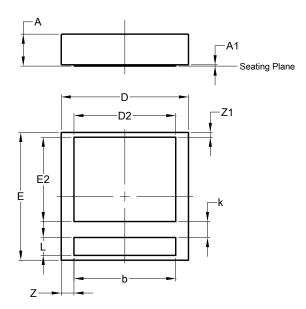


t1, PULSE DURATION TIME (sec) Figure 5 Single Pulse Maximum Power Dissipation



Package Outline Dimensions

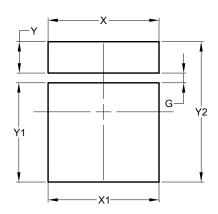
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



| U-DFN2020-2 (Type B) | | | | | | | |
|-------------------------|----------------|------|------|--|--|--|--|
| Dim | Min Max Typ | | | | | | |
| Α | 0.47 | 0.53 | 0.50 | | | | |
| A1 | 0.00 | 0.05 | 0.02 | | | | |
| b | 1.55 | 1.65 | 1.60 | | | | |
| D | 1.95 2.05 2.00 | | | | | | |
| D2 | 1.50 1.70 1.60 | | | | | | |
| Е | 1.95 2.05 2.00 | | | | | | |
| E2 | 1.22 | 1.42 | 1.32 | | | | |
| k | 0.25 BSC | | | | | | |
| L | 0.23 | 0.33 | 0.28 | | | | |
| Z | 0.20 BSC | | | | | | |
| Z 1 | 0.075 BSC | | | | | | |
| All Dimensions in mm | | | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value | | |
|------------|---------|--|--|
| Dimensions | (in mm) | | |
| G | 0.150 | | |
| Х | 1.700 | | |
| X1 | 1.700 | | |
| Υ | 0.480 | | |
| Y1 | 1.520 | | |
| Y2 | 2.150 | | |



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